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HEET

U.S. DEPARTMENT OF COMMERCE
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8/952609

To the Honorable Commissioner of Patents



Shed original document(s) or copy(ies) thereof.

1. Name of conveying party(ies):

100680074

address of receiving party(ies):

(1) Noboru KATSUKURA; (2) Takehiko YAMADA;
(3) Koji MISHIMA; (4) Akinori NISHII; (5) Sota
NAKAGAWA; (6) Eiji TOCHIKUBOName: EBARA CORPORATION

Internal Address: _____

Street Address: 11-1, Haneda Asahi-cho, Ohta-ku,
Tokyo, JapanAdditional name(s) of conveying party(ies) attached? No

City: _____, State: _____ ZIP: _____

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____Execution Date: January 5, 1998Additional name(s) & address(es) attached? No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: January 5, 1998

A. Patent Application No.(s)

08/952,609

B. Patent No.(s)

Additional numbers attached? No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WENDEROTH, LIND & PONACKInternal Address: Attn: Mr. Jeffrey NoltonStreet Address: 2033 "K" Street, N.W., Suite 800City: Washington, State: DC ZIP: 200066. Total number of applications and patents involved: 17. Total fee (37 C.F.R. § 3.41). \$ 40.00☒ Enclosed [Check No. 27601]☐ Authorized to be charged to deposit account8. Deposit account number: 23-0975

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Jeffrey Nolton, Reg. No. 25,408

Name of Person Signing

Signature

March 9, 1998

Date

Total number of pages including cover sheet, attachments, and document: 3

Mail documents to be recorded with required cover sheet information to:

03/16/1998 PVOLPE 00000014 08952609 40.00 DP
02/FC:581Commissioner of Patents and Trademarks
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Washington, D.C. 20231THE COMPTON SYSTEMS CORPORATION
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PATENT ATTACHMENT F

REEL: 9063 FRAME: 0597

Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

**Insert Name(s)
of Inventor(s)** Noboru KATSUKURA
Takehiko YAMADA
Koji MISHIMA
Akinori NISHII
Sota NAKAGAWA and
Eiji TOCHIKUBO

the undersigned hereby sell(s) and assign(s) to

**Insert Name
of Assignee** EBARA CORPORATION
Address of 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144 Japan

(hereinafter designated as the Assignee) the entire right, title and interest for the United States of America as defined in 35 USC 100, in the invention known as

**Title of
Invention** METHOD FOR AEROBICALLY TREATING LIQUID-WASTE AND TREATMENT
TANK (PCT/JP96/01365, filed on May 23, 1996)

for which an application for patent in the United States of America has been executed by the undersigned

**Date of Signing
of Application** on January 5, 1998

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the Rule of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date January 5, 1998, Name of Inventor Naoru Katsukawa
Date January 5, 1998, Name of Inventor Takeshiko Yamada
Date January 5, 1998, Name of Inventor Koji Matsuura
Date January 5, 1998, Name of Inventor Naoru Nishida
Date January 5, 1998, Name of Inventor Kota Nakagawa
Date January 5, 1998, Name of Inventor Koji Tachibana

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Jun-ichiro Morinaga
Witness Hirohiko Kato

ACKNOWLEDGMENT

_____ } ss
_____ }

This _____ day of _____, 19____, before me
personally came the above-named _____

_____ to me personally known as the individual(s) who executed the foregoing assignment, who did
acknowledge to me that he (they) executed the same of his (their) own free will for the pur-
poses therein set forth.

SEAL

Official Signature

Official Title

The above application may be more particularly identified as follows:

U. S. Application Serial No. _____ Filing Date _____
Applicant Reference Number _____ Atty. Docket No. _____
Title of Invention _____
